#### 504756293 01/31/2018

# PATENT ASSIGNMENT COVER SHEET

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**SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT** 

#### **CONVEYING PARTY DATA**

Name	Execution Date
VEERESH V. DESHPANDE	10/20/2015
HOWARD S. LANDIS	10/19/2015
ARUN S. MAMPAZHY	10/20/2015
NEELIMA MANDLOI	10/20/2015

### **RECEIVING PARTY DATA**

Name:	International Business Machines Corporation
Street Address:	New Orchard Road
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15884573

### **CORRESPONDENCE DATA**

Fax Number: (518)449-0047

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 518-449-0044

Email: ptocommunications@hoffmanwarnick.com,

sadonnino@hoffmanwarnick.com

**Correspondent Name:** HOFFMAN WARNICK LLC

Address Line 1: 540 BROADWAY Address Line 2: 4TH FLOOR

Address Line 4: ALBANY, NEW YORK 12207

ATTORNEY DOCKET NUMBER: IN920150166US2	
NAME OF SUBMITTER:	MATTHEW B. PINCKNEY
SIGNATURE:	/Matthew B. Pinckney/
DATE SIGNED:	01/31/2018
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 8** 

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# DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of lavention: MODIFYING DESIGN LAYER OF INTEGRATED CIRCUIT (IC)

As a below named inventor, I hereby declare that:
This declaration is directed to the anached application, or (if following box is checked):
[ ] United States application or PCT international application numberfiled on
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the contents of the application, including the claims.
I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.

Whereas, the undersigned inventor(s) has have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document:

Whereas, International Business Machines Corporation, a corporation of New York having a place of business at Armonk, New York (herein referred to as "IBM"), desires to acquire, and each undersigned inventor desires to grant to IBM, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being bereby acknowledged. each undersigned inventor ("ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to H3M (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or gramed therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issist any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors. legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned inventor neknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not

Page 1 of 2

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1)	Legal Name of Inventor: Vecresh V. Deshpande	
	Signature:	Date: 20/20/2003
(2)	Legal Name of Inventor: Howard S. Landis	
	Signature:	Date:
(3)	Legal Name of Inventor: Aran S. Mampazhy	
	Signature:	Date
(4)	Legai Name of Inventor: Neelima Mandioi	
	Signature:	Date:

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(1)	Legal Name of inventor: Vectesh V. Deshpande	
	Signature:	
(2)	Logal Name of Inventor: Howard S. Landis	∢.
	Signature: <u>Augus Saufis</u>	Date: 44 19 2015
(3)	Legal Name of Inventor: Arus S. Mampazhy	
	Signature:	Deto:
(4)	Legal Name of Inventor: Neelima Mandioi	
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(i) Legal Name of Inventor: Veeresh V. Deshpande	
Signature:	Date:
(2) Legal Name of Inventor: Howard S. Landis	
Signature:	Date:
(3) Legal Name of Inventor: Aran S. Mampazhy	
Signature: <u>AA</u>	Date: 20 OC 7 2015
(4) Legal Name of Inventor: Neelima Mandloi	
Signature:	Oute:

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	Signature:	Date: 10 - 20 - 2015

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